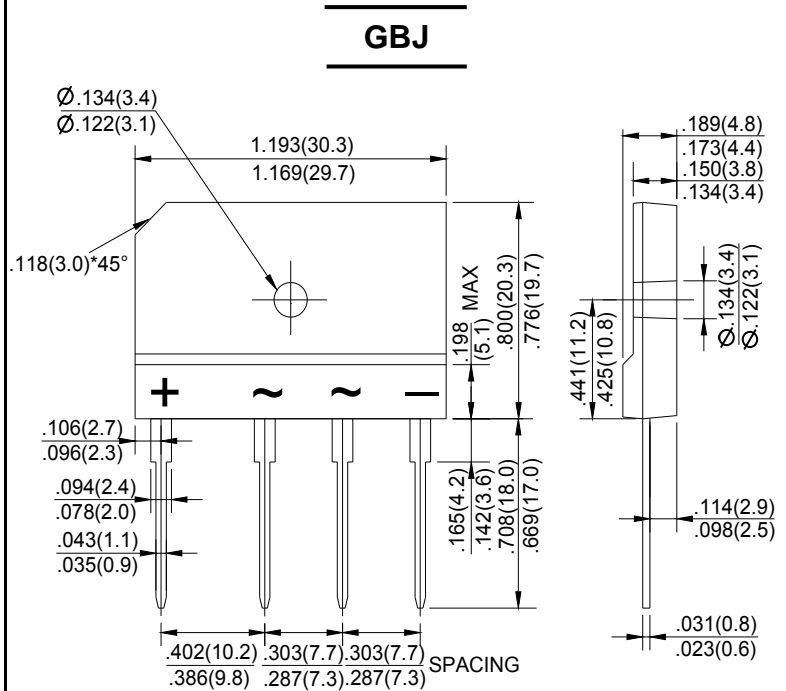


## GLASS PASSIVATED BRIDGE RECTIFIERS

REVERSE VOLTAGE - 50 to 1000Volts  
FORWARD CURRENT - 25 Amperes

### FEATURES

- Rating to 1000V PRV
- Ideal for printed circuit board
- Low forward voltage drop, high current capability
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- The plastic material has UL flammability classification 94V-0
- AEC-Q101 qualified



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	GBJ 25005	GBJ 2501	GBJ 2502	GBJ 2504	GBJ 2506	GBJ 2508	GBJ 2510	UNIT
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (with heatsink Note 2) @ T <sub>c</sub> =100°C (without heatsink)	I <sub>(AV)</sub>	25.0 4.2							A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>	350							A
Maximum Forward Voltage at 12.5A DC	V <sub>F</sub>	1.0							V
Maximum DC Reverse Current @ T <sub>J</sub> =25°C at Rated DC Blocking Voltage @ T <sub>J</sub> =125°C	I <sub>R</sub>	5.0 500							μA
I <sup>2</sup> t Rating for Fusing (t<8.3ms)	I <sup>2</sup> t	508							A <sup>2</sup> s
Typical Junction Capacitance Per Element (Note1)	C <sub>J</sub>	85							pF
Typical Thermal Resistance to Ambient ( Note2)	R <sub>θJA</sub>	4.5							°C/W
Typical Thermal Resistance to case( Note2)	R <sub>θJC</sub>	0.6							
Typical Thermal Resistance to lead ( Note2)	R <sub>θJL</sub>	1.5							
Operating Temperature Range	T <sub>J</sub>	-55 to +150							°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150							°C

NOTES: 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
2. Device mounted on 300mm\*300mm\*1.6mm Cu plate heatsink.  
3. The typical data above is for reference only(典型值仅供参考).

FIG.1-FORWARD CURRENT DERATING CURVE

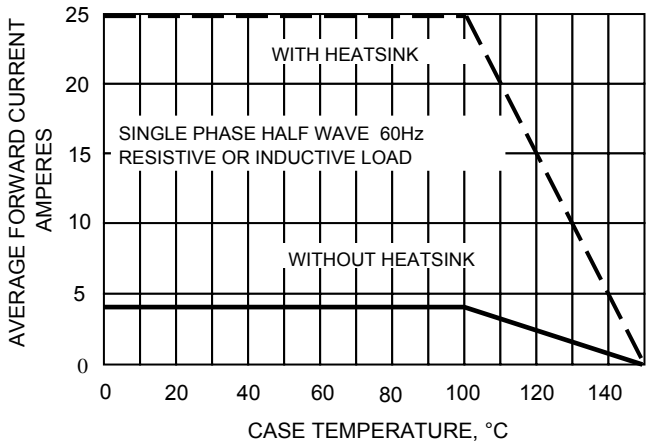


FIG.2-MAXMUN NON-REPETITIVE SURGE CURRENT

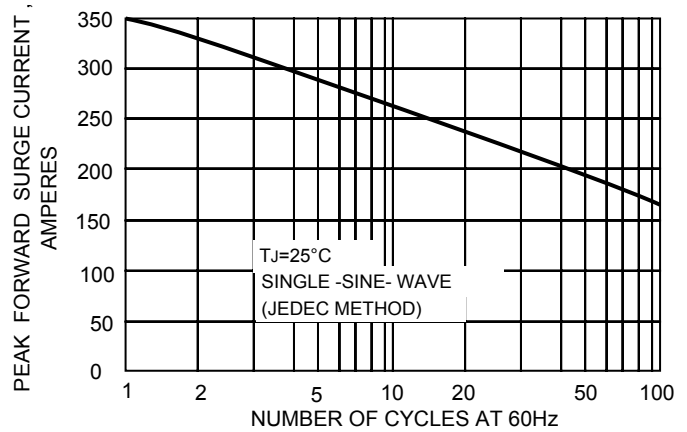


FIG.3-TYPICAL JUNCTION CAPACITANCE

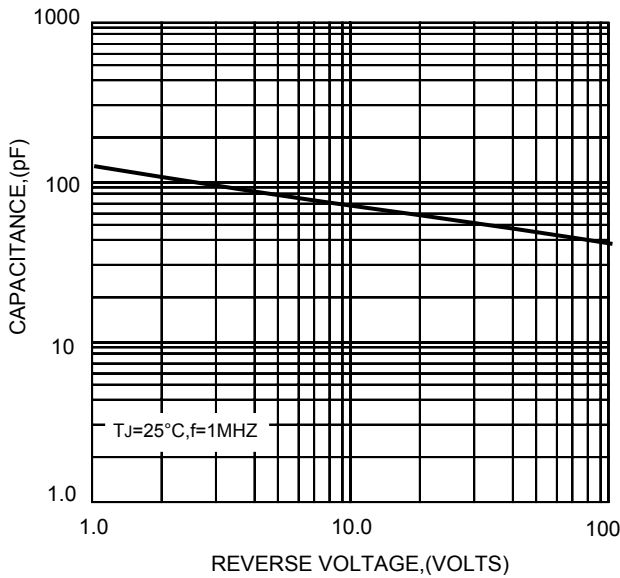


FIG.4-TYPICAL FORWARD CHARACTERISTICS

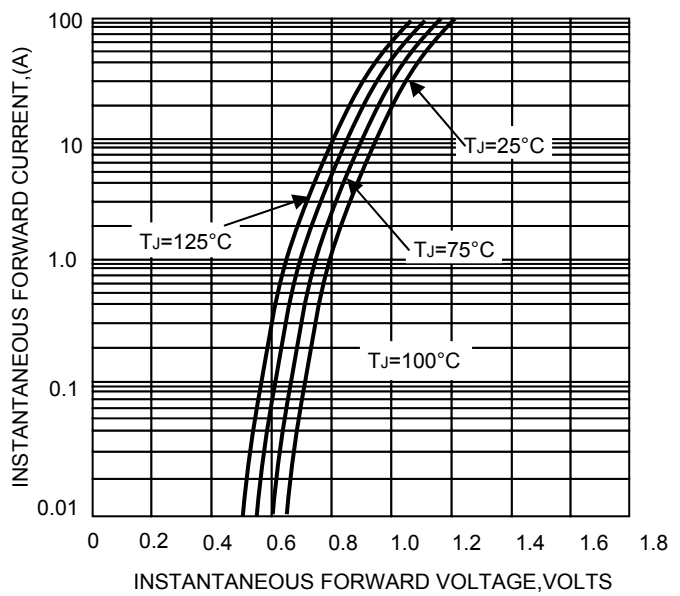
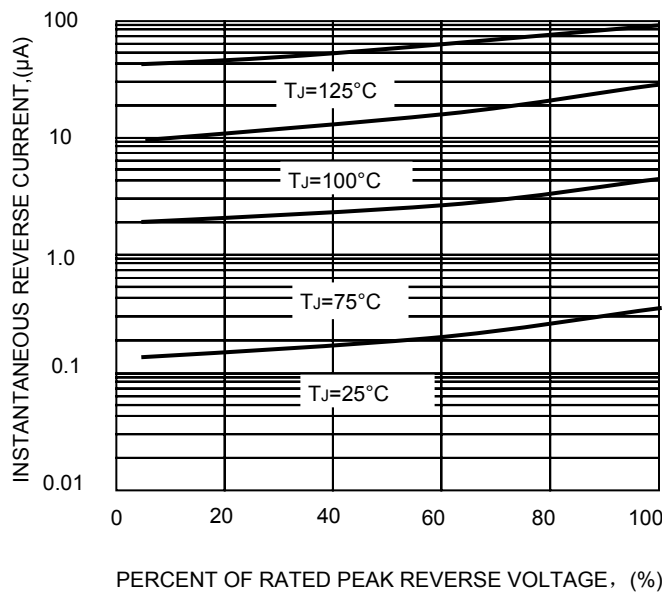


FIG.5-TYPICAL REVERSE CHARACTERISTICS



The curve graph is for reference only, can't be the basis for judgment(曲线图仅供参考)!



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